



# Damage on Materials of interest for FEL optics

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+  
„damage team“

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- + *for LCLS experiment*
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- + *for SCSS experiment*
  - C. Svetina, A. Bianco - *Sincrotrone Trieste*
  - M. Nagasono - *XFEL Project, Riken*



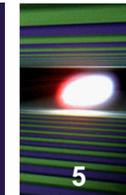
Why studying damage as up to now no problems occurred?

- extending the FEL parameters / optics :
  - energy up to 200 mJ / pulse\*
  - photon energy range: water window,  $h\nu > x$  10 keV
  - specific structures: multilayer, grating, zp...
  
- fundamental aspects: interaction of intense X-ray fs pulses with solids
  - bulk material: PMMA, Si, SiO<sub>2</sub>, diamond
    - » needed for beam characterization

*\*Yurkov et al. DESY Print TESLA-FEL 2011-01*

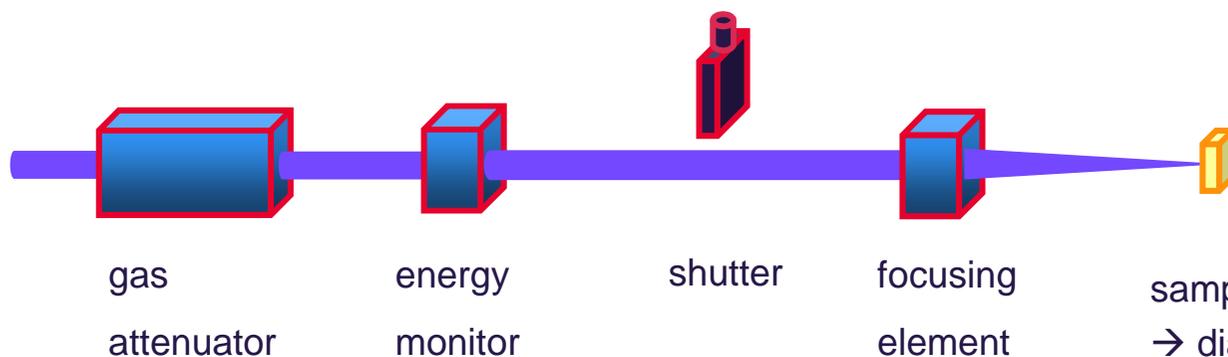


- Experiment
  - set-up
  - normal incidence case
- X-ray mirror specific geometry
  - FLASH results
  - Effect of electron transport
  - Multi-layer case
- Beam characterization by ablation
- Conclusion and developments

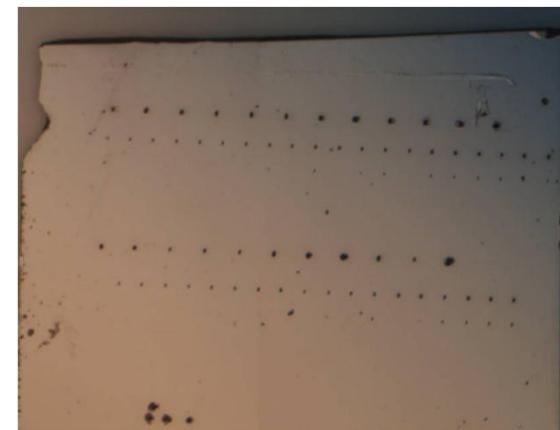


## ■ 1<sup>st</sup> step: beamtime

- SCSS : 20, 24 eV
- FLASH : 12, 38, 91, 177 eV
- LCLS : 830 eV



→ diamond, aC, ML, Au, PMMA etc...

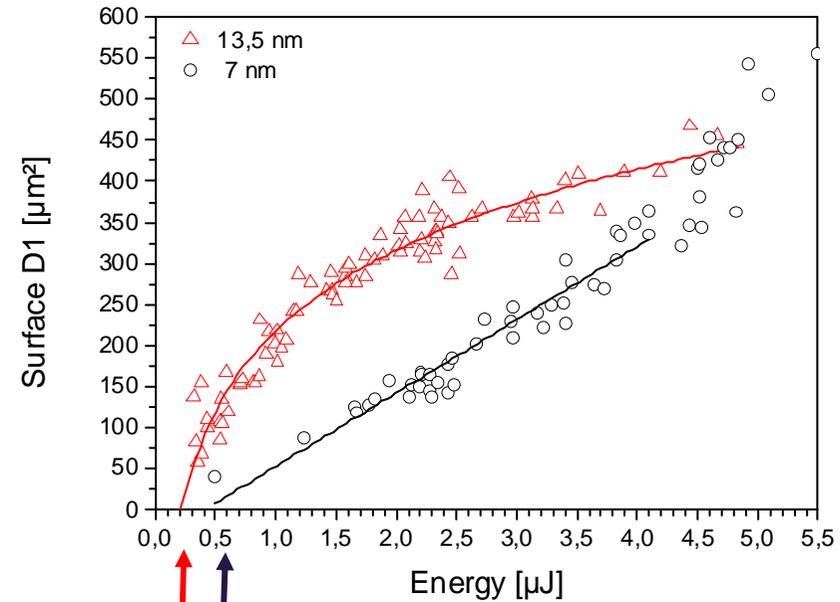
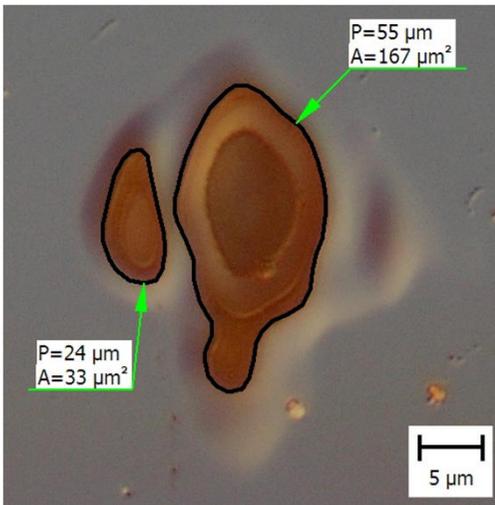
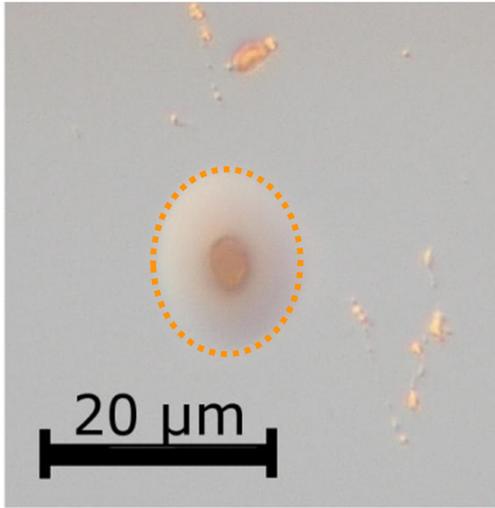


## ■ 2<sup>nd</sup> step: damage analysis

- surface morphology: DIC microscope, AFM, SEM
- structure : micro-Raman, x-ray diffraction (XRD), ESCA



## Normal incidence



$E_{th}$ : energy damage threshold

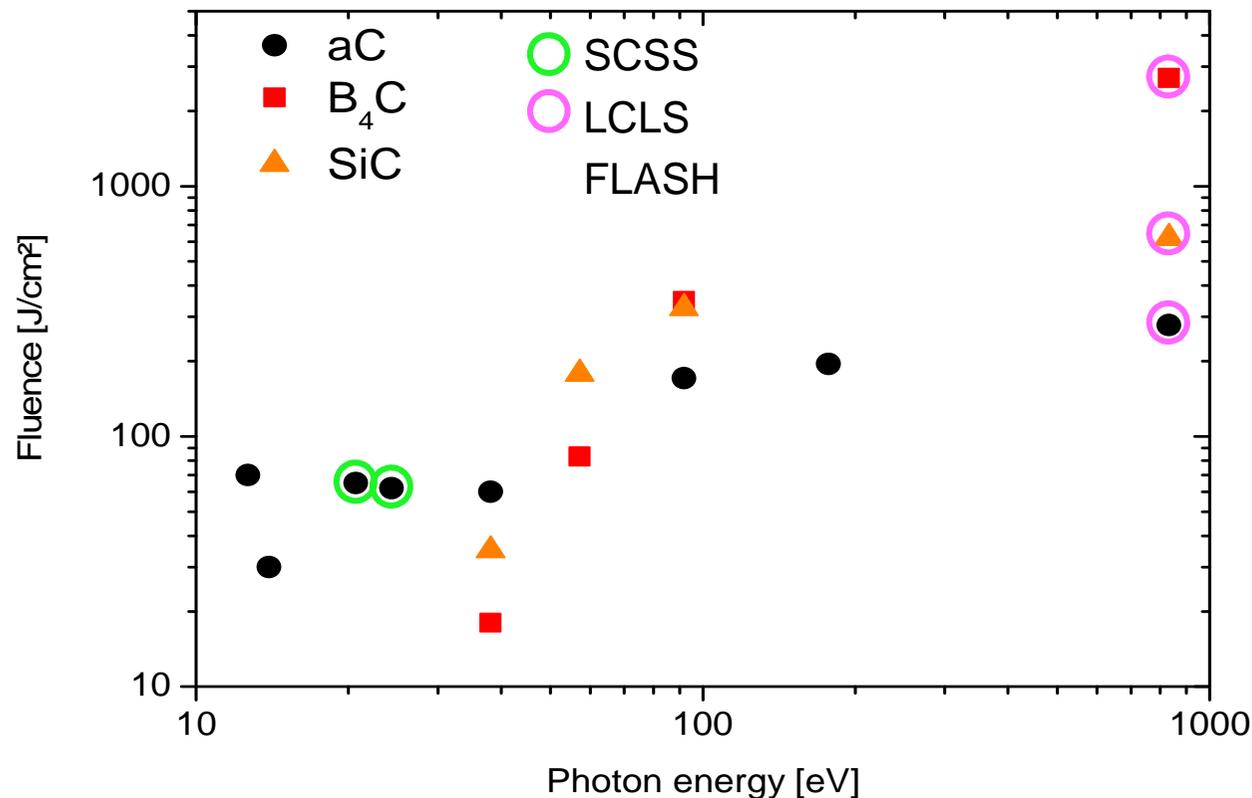
## Fluence damage threshold

$$F_{th} \text{ (J.cm}^{-2}\text{)} = E_{th} / A_{eff}$$

beamsize needed => effective area method<sup>+</sup>



Normal incidence, single shot damage threshold for mirror coating materials: aC, SiC and B<sub>4</sub>C



Summary of:

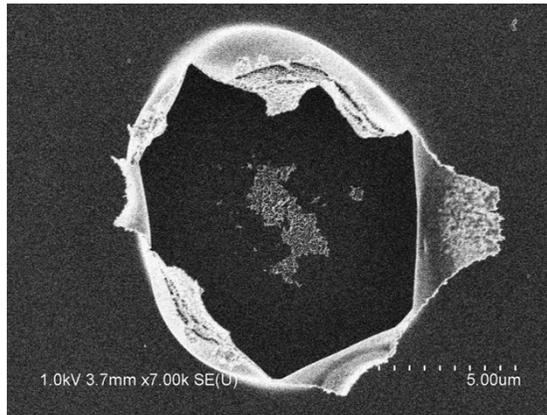
- APL, **84** 657 (2004)
- JAP, **101** 043107(2007)
- APL, **90** 173128 (2007)
- APL, **95** 111104 (2009)
- APL, **95** 031111 (2009)
- Opt.Expr., **28** 23933 (2010)
- to be published

→ clear photon energy dependance of the damage threshold:  
**experiments needed!**

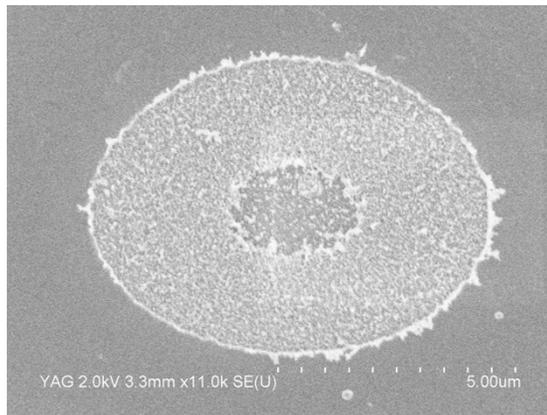


x-ray mirror : thin layer ~ 40 nm

40 nm



940 nm

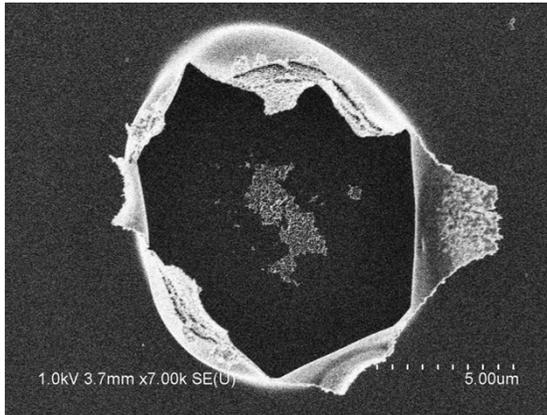


**1  $\mu$ J – 13.5 nm / 91 eV**

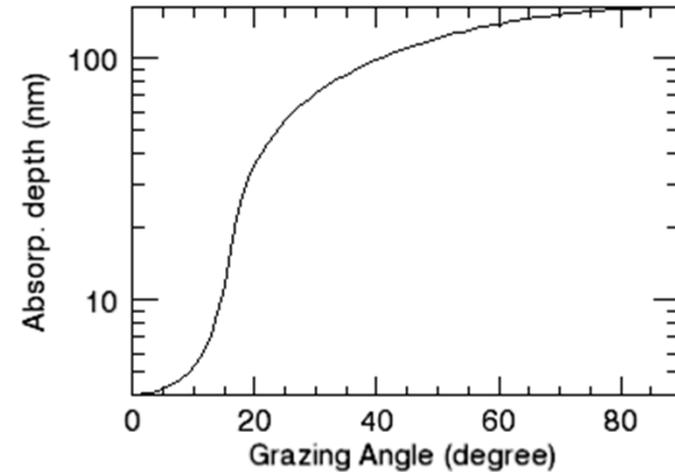
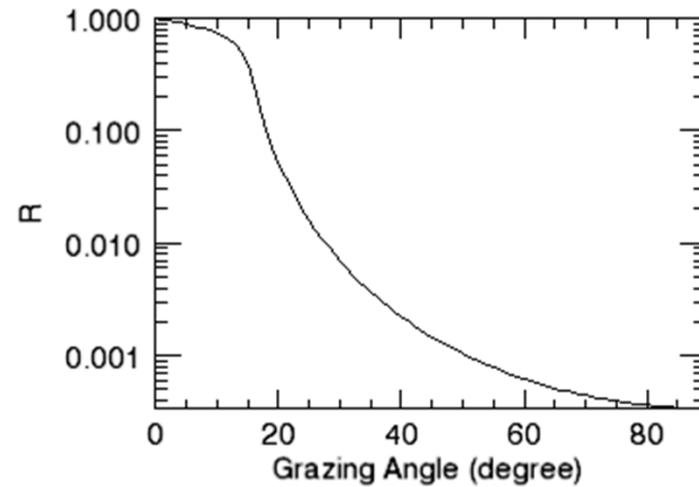
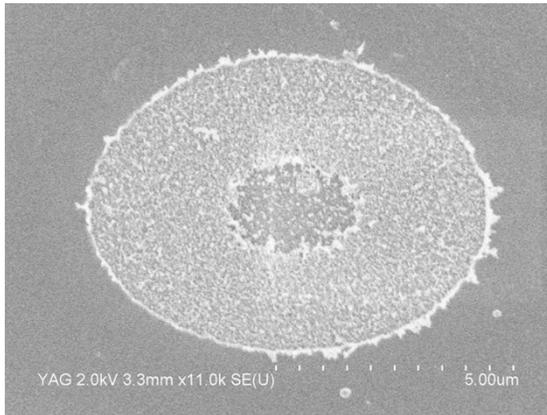


x-ray mirror : thin layer ~ 40 nm, small grazing angle  $< \theta_c$

40 nm



940 nm



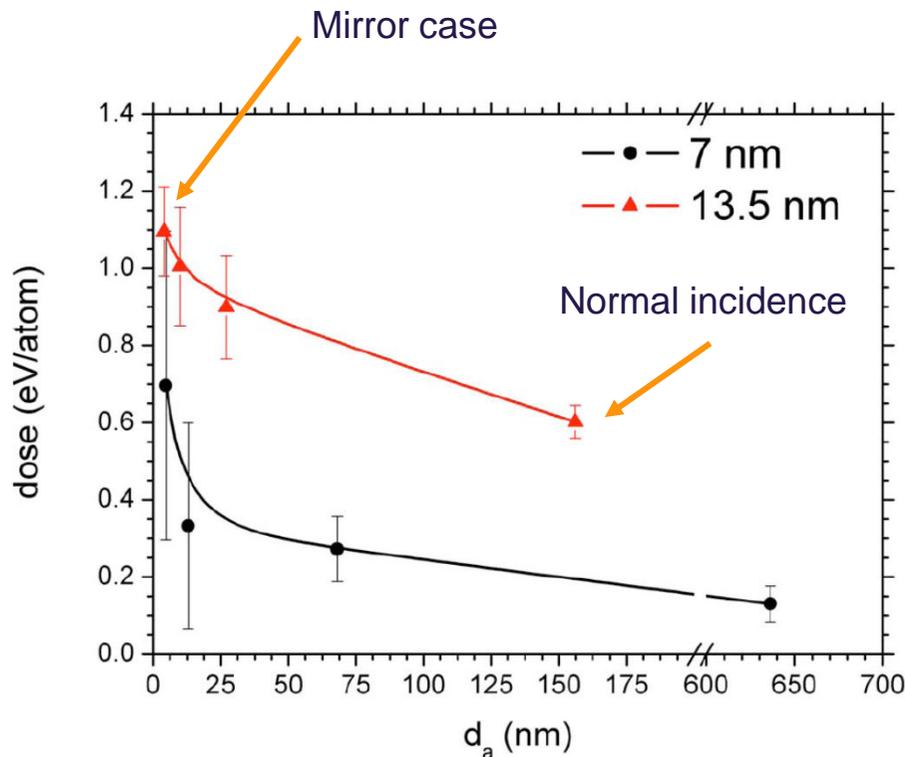
**1  $\mu$ J – 13.5 nm / 91 eV**



- Energy absorbed per atom = dose (eV/atom)

$$D_{th} = F_{th} \cdot \frac{(1-R)}{l_a \cdot n_a}$$

- $l_a$  : absorption depth
- $R$  : reflectivity
- $n_a$  : atomic density

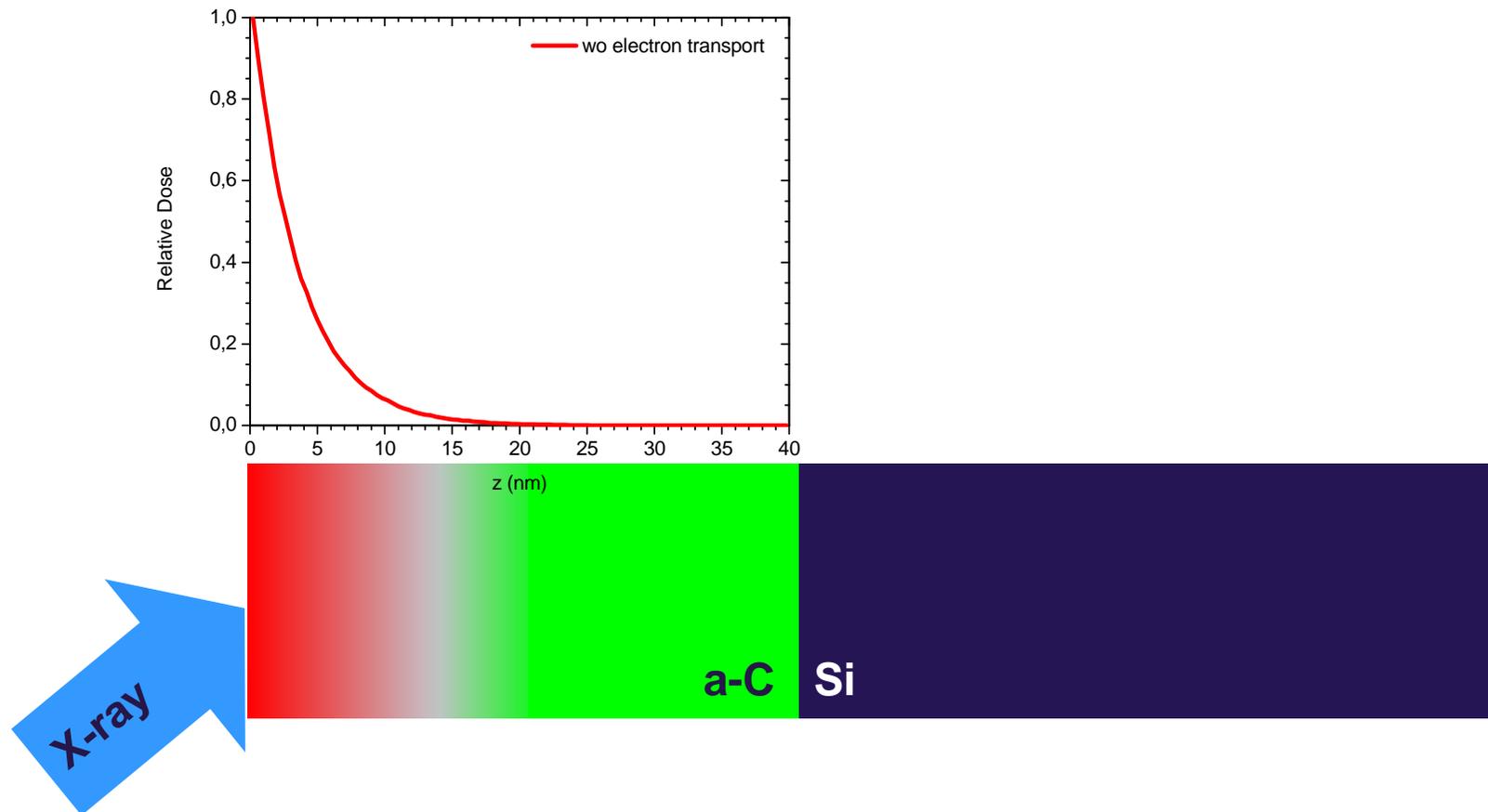


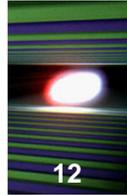
**Below  $\theta_c$**

→  $D_{th} = 2 \text{ to } 3 \times D_{th} (90^\circ)$



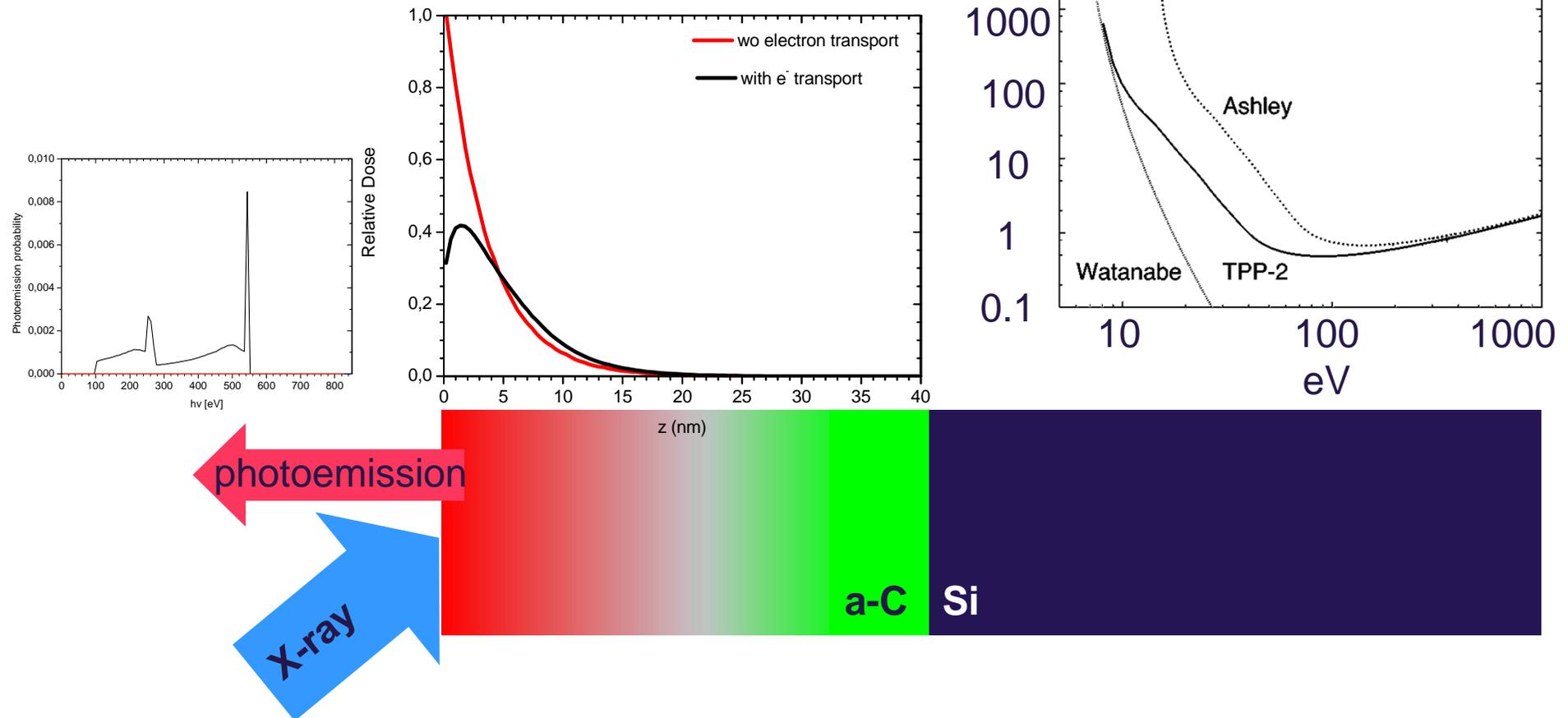
- effect of electron transport: MC simulations – 830 eV





## ■ effect of electron transport: MC simulations – 830 eV

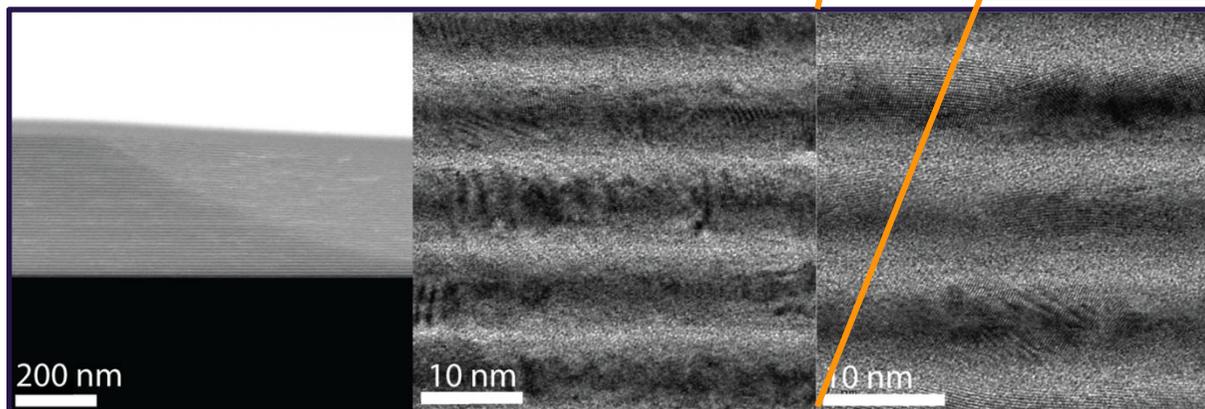
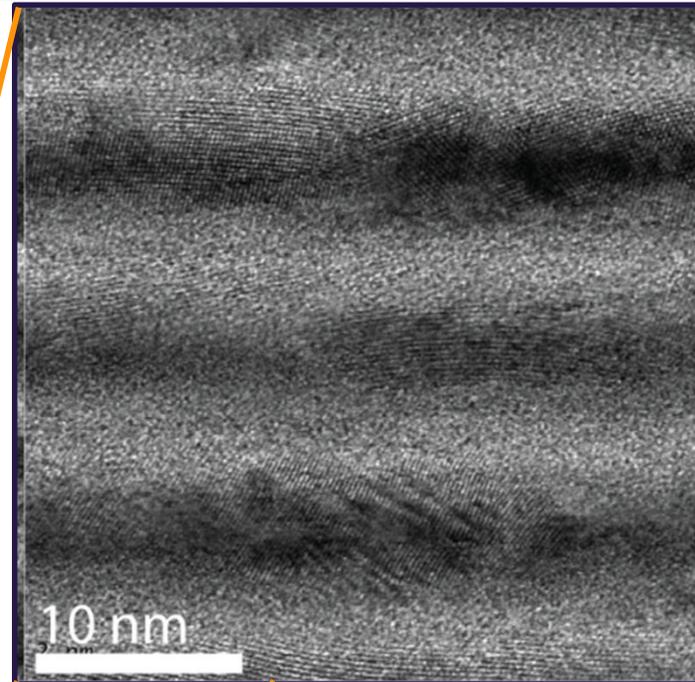
B. Ziaja JAP **97**, 064905 (2005)



Single shot damage at “resonance – angle” for 2 structures at 13,5 nm FLASH:

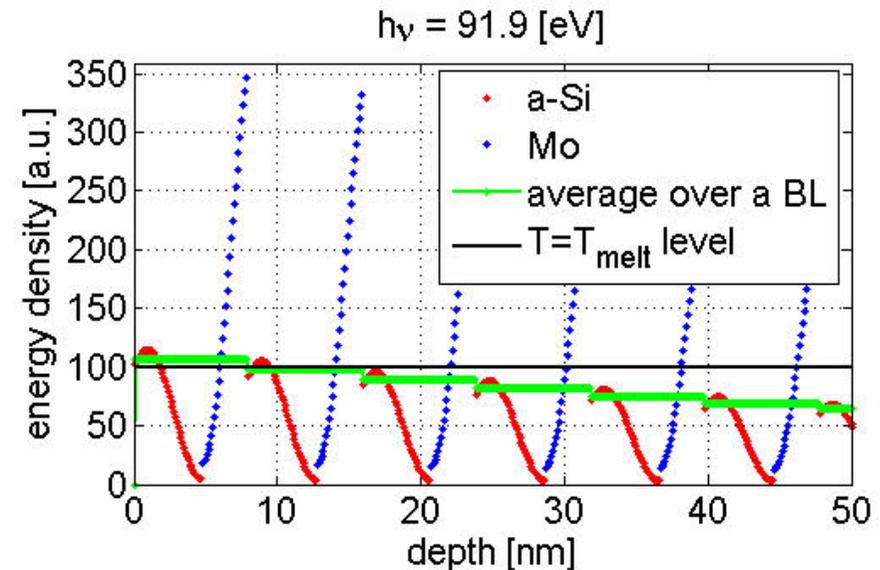
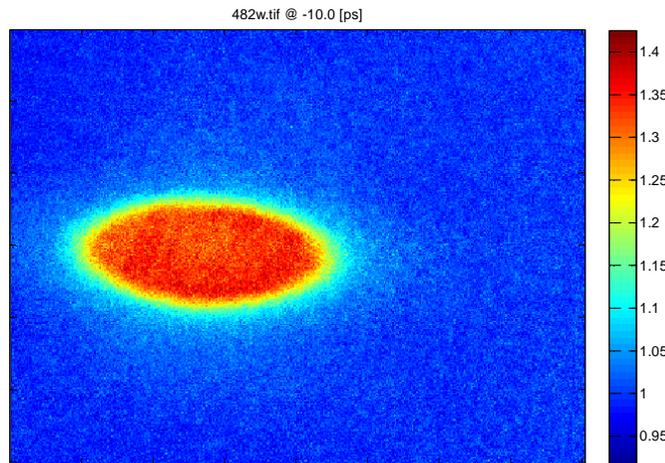
$$\text{Mo / Si } F_{\text{th}} = 45 \pm 7 \text{ mJ/cm}^2$$

$$\text{MoN /SiN } F_{\text{th}} = 48 \pm 7 \text{ mJ /cm}^2$$



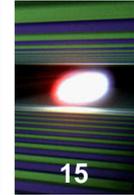
- a. Zoomed in on the side of the crater
- b. undisturbed Mo/Si ML structure – crystalline Mo and amorphous Si layers
- c. inside the crater – instead of a-Si, crystalline silicides formation due to the melting of a-Si and enhanced atomic diffusion

## Single shot damage at “resonance –angle” for 2 structures at 13,5 nm FLASH: Mo / Si and MoN /SiN



XUV pump – optical probe (time resolved microscopy image @ 10 ps delay w/r the XUV pulse) 40% increase of reflectance due to the a-Si layer melting

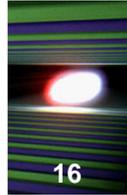
Calculated energy deposited: 13,5 nm FLASH: Mo / Si



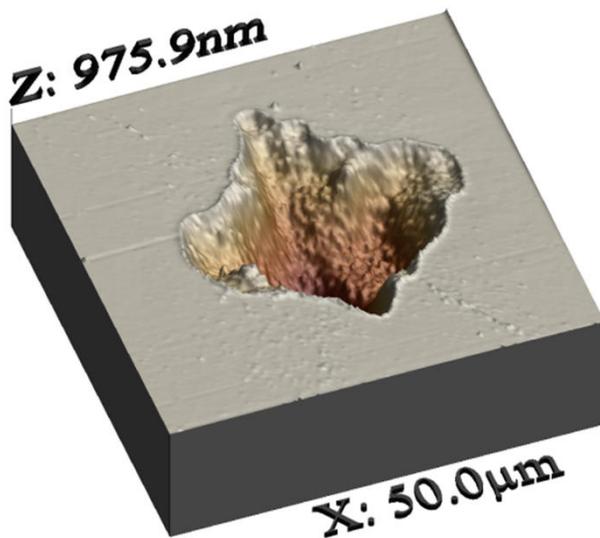
## Main results:

- No changes in the reflectivity during the fs FEL pulse.
- Energy density deposited in the sample's surface via absorption is the highest for the on-resonant conditions (Bragg reflection) in spite of the higher reflectivity.
- The depth-profile of the radiation energy deposited in the sample is smoothed by fast heat diffusion process by electrons.
- At the damage threshold the (averaged over a bilayer) energy density at the surface corresponds to the energy density required for melting of one of the multilayer materials.

More details:      A. R. Khorsand, R. Sobierajski, et al. Opt. Express **18**,700 (2010).  
                         R. Sobierajski, S. Bruijn et al. Opt. Express **19**, 193 (2011)



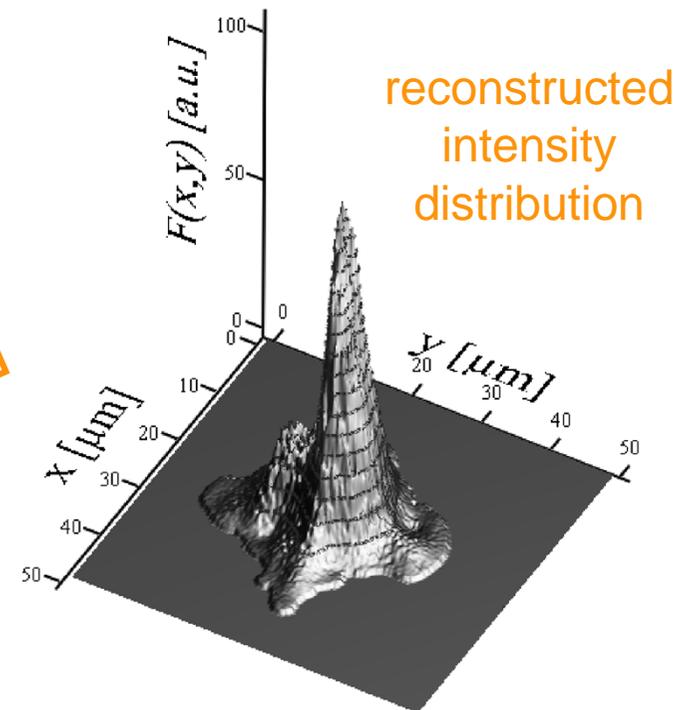
## Initial beam imprint



## Application:

- Spot size measurements
- Optics setting / optimization

reconstruction



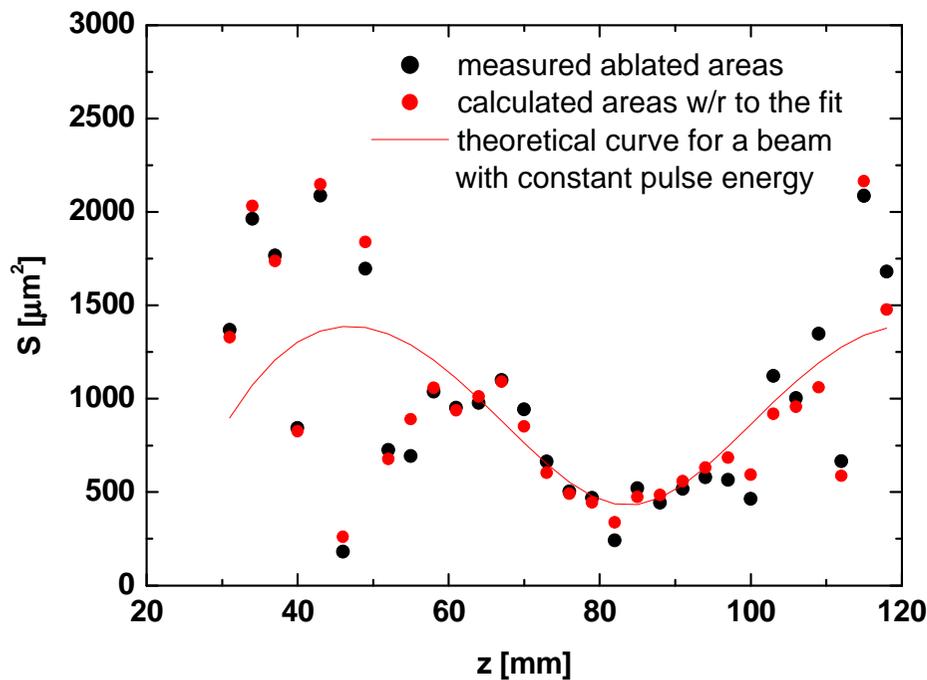
A reconstructed beam profile depicting inhomogeneities and deviations from an ideal Gaussian beam.

Chalupsky et al., *Opt. Express* **15**, 6036 (2007).  
Chalupsky et al., *Opt. Express* **18**, 27836 (2010).



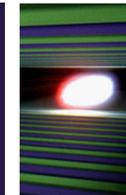
## Caustic curve measurements : FLASH , 7 nm

Assuming a stigmatic beam : 
$$S(z, F_0) = S_{foc} \left( 1 + \frac{(z - z_c)^2}{z_0^2} \right) \left( \ln \frac{F_0}{F_{th}} - \ln \left( 1 + \frac{(z - z_c)^2}{z_0^2} \right) \right)$$

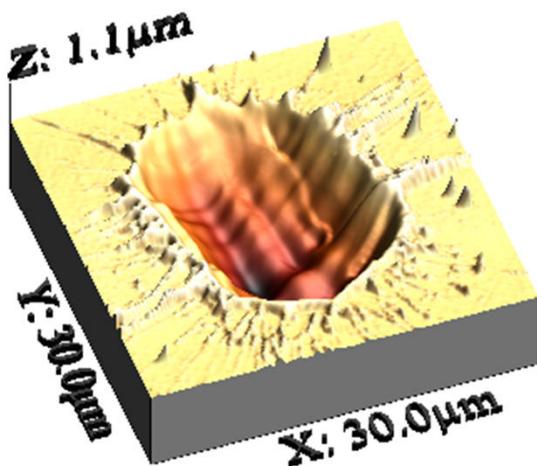


$$\begin{aligned}
 S_{foc} &= (127 \pm 19) \mu\text{m}^2 \\
 z_c &= (83.7 \pm 0.7) \text{mm} \\
 z_0 &= (11.7 \pm 1.1) \text{mm} \\
 \ln(E_{th}) &= (-2.07 \pm 0.15) \ln(\mu\text{J})
 \end{aligned}$$

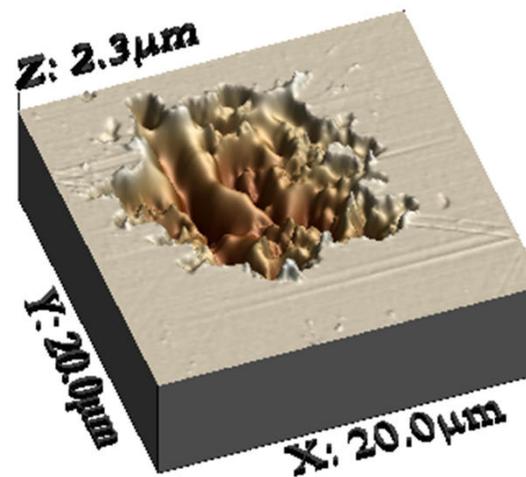
Here,  $S_{foc}$  is the focal spot area,  $z_c$  the beam waist position,  $z_0$  the Rayleigh range,  $F_{th}$  the threshold fluence, and  $F_0$  the peak fluence at the focus.



## PbWO<sub>4</sub>: a good candidate for short wavelengths



- an ablative imprint in PbWO<sub>4</sub> created by 6Å LCLS radiation (2keV) out of the focus (AMO station, Sep 2009)
- the pulse energy adjusted by a gas attenuator (T=1%)
- no Be filters used
- in principle usable for beam profile reconstruction at 2keV



- an ablative imprint in PbWO<sub>4</sub> created by 6Å LCLS radiation (2keV) out of the focus
- the pulse energy adjusted by a gas attenuator (T=2%)
- Be filters used (T=20%)
- a micron-sized speckle structures indicate that the wavefront has been shattered by the Be filter

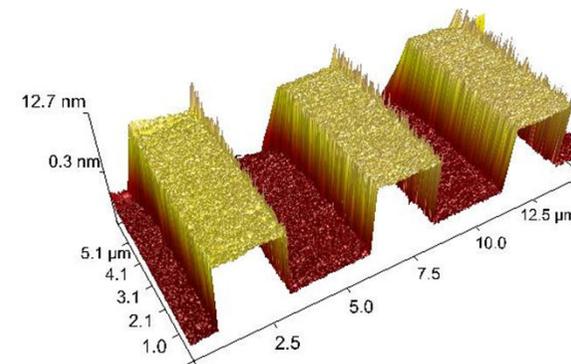


## May 2011: Core team + „3 sites“ collaboration

- new material non C based for H<sub>2</sub>O window  
→ current mirror: aC, B<sub>4</sub>C, SiC -> Ni, B(?)

91 eV	aC	Ni*	Cr*
F (mJ/cm <sup>2</sup> )	171±40	54±5	60±10

- damage on grating structure



- Multishot damage process?
- specific targets for in-situ spot characterization



## What DAMAGE STUDIES can do for you:

- design of beamline: single shot damage
  - » optical coatings
  - » ML / grating
  - » crystal x-ray monochromator / beam diagnostic
  - » .....everything that goes in the beam
  
- beam characterization
  
- optimization of focusing optics device